



#### 100V N-CHANNEL ENHANCEMENT MODE MOSFET

#### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C
100V	$23m\Omega$ @ $V_{GS} = 10V$	7.4A
	$30m\Omega$ @ $V_{GS} = 6V$	6.5A

### **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>), yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- High Frequency Switching
- Synchronous Rectification
- DC-DC Converters

#### **Features and Benefits**

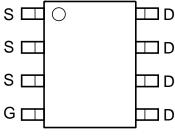
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low R<sub>DS(ON)</sub> Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### **Mechanical Data**

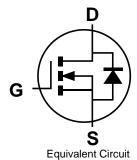
- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.074 grams (Approximate)



Top View



Top View Internal Schematic



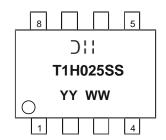
### **Ordering Information** (Note 4)

Part Number	Case	Packaging
DMT10H025SSS-13	SO-8	2,500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

## **Marking Information**



⊃!! = Manufacturer's Marking T1H025SS = Product Type Marking Code YYWW = Date Code Marking YY or YY = Year (ex: 17 = 2017) WW = Week (01 to 53)



### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		$V_{DSS}$	100	V
Gate-Source Voltage		$V_{GSS}$	±20	V
Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	7.4 5.9	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I <sub>DM</sub>	45	Α
Maximum Continuous Body Diode Forward Current (Note 6)		Is	3.2	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)		I <sub>SM</sub>	45	А
Avalanche Current, L = 0.1mH		I <sub>AS</sub>	25	Α
Avalanche Energy, L = 0.1mH		E <sub>AS</sub>	31.25	А

# Thermal Characteristics (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25$ °C	$P_{D}$	1.4	W
Thermal Resistance, Junction to Ambient (Note 5)		$R_{\theta JA}$	91	°C/W
Total Power Dissipation (Note 6)	$T_A = +25$ °C	$P_{D}$	1.9	W
Thermal Resistance, Junction to Ambient (Note 6)		$R_{\theta JA}$	65	°C/W
Total Power Dissipation (Note 6)	$T_C = +25^{\circ}C$	$P_{D}$	12.9	W
Thermal Resistance, Junction to Case (Note 6)		$R_{ heta JC}$	8.5	°C/W
Operating and Storage Temperature Range	•	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

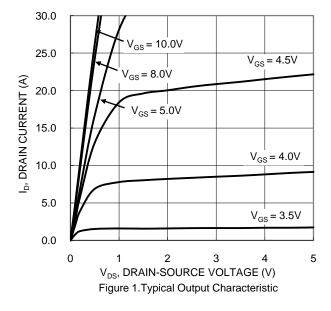
# **Electrical Characteristics** (T<sub>A</sub> = +25°C, unless otherwise specified.)

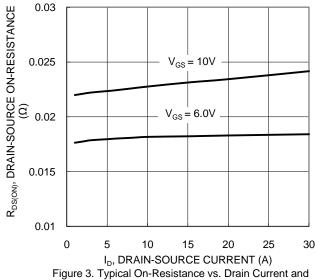
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	100	_	_	V	$V_{GS} = 0V$ , $I_D = 1mA$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	l	_	1	μΑ	$V_{DS} = 80V$ , $V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	2		4	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
Ctatia Dunia Causas On Desistence		_	17	23	0	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>		22	30	mΩ	V <sub>GS</sub> = 6V, I <sub>D</sub> = 12.5A	
Diode Forward Voltage	$V_{SD}$		0.9	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 20A	
DYNAMIC CHARACTERISTICS (Note 8)			•				
Input Capacitance	Ciss	_	1544	_			
Output Capacitance	Coss		250	_	pF	$V_{DS} = 50V, V_{GS} = 0V, f = 1MHz$	
Reverse Transfer Capacitance	Crss	-	20.4	_			
Gate Resistance	Rg	_	1.26	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 10V)	$Q_{g}$	l	21.4	_		V <sub>DD</sub> = 50V, I <sub>D</sub> = 20A	
Total Gate Charge (V <sub>GS</sub> = 6V)	Qg	-	13.4	_	nC		
Gate-Source Charge	Q <sub>gs</sub>	l	4.6	_	110		
Gate-Drain Charge	$Q_{gd}$	-	6.0	_			
Turn-On Delay Time	t <sub>D(ON)</sub>	_	8.2	_		$V_{DD} = 50V, V_{GS} = 10V,$ $I_{D} = 20A, R_{g} = 11\Omega$	
Turn-On Rise Time	t <sub>R</sub>	_	11.2	_	20		
Turn-Off Delay Time	t <sub>D(OFF)</sub>	-	27.5	_	ns		
Turn-Off Fall Time	t <sub>F</sub>		13.7	_			
Body Diode Reverse Recovery Time	t <sub>RR</sub>		37.5	_	ns	I 20A di/dt _ 100A/ug	
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>		50.9	_	nC	$I_F = 20A$ , di/dt = 100A/ $\mu$ s	

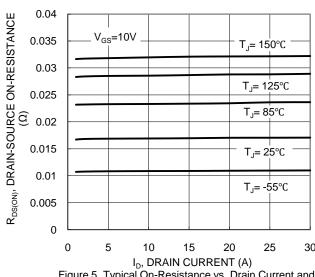
 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing. Notes:





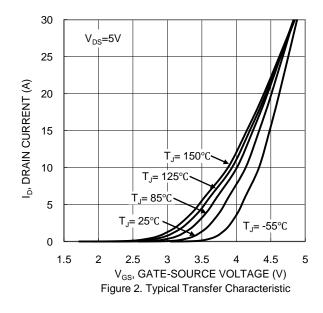


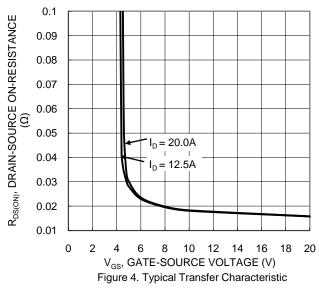




Gate Voltage

Figure 5. Typical On-Resistance vs. Drain Current and Temperature





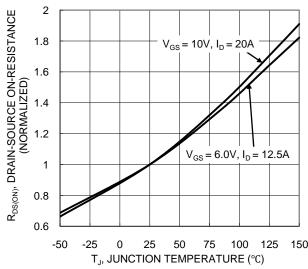


Figure 6. On-Resistance Variation with Temperature





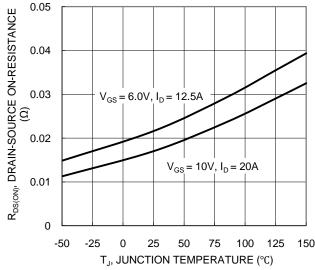
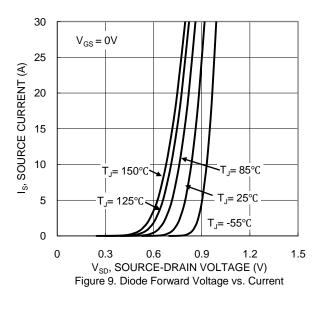


Figure 7. On-Resistance Variation with Temperature



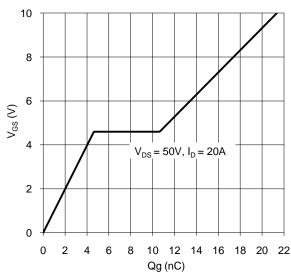
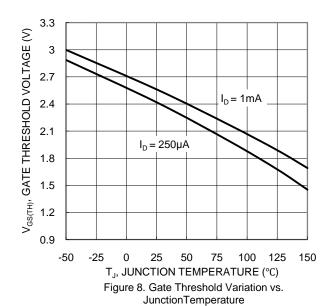
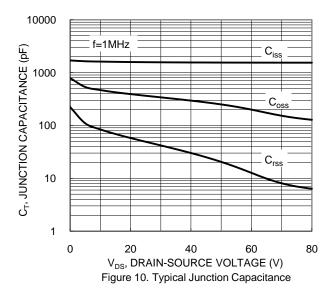
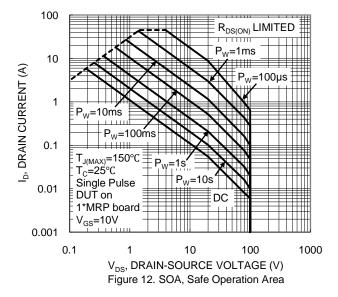


Figure 11. Gate Charge









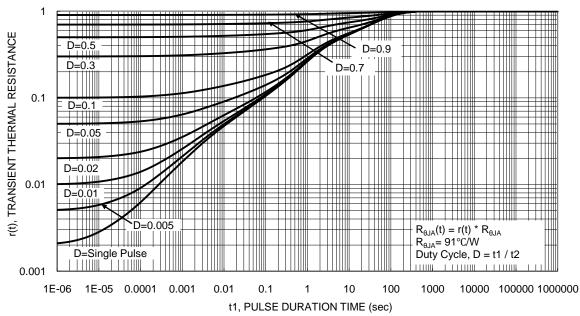


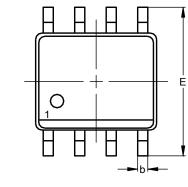
Figure 13. Transient Thermal Resistance

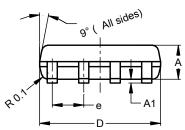


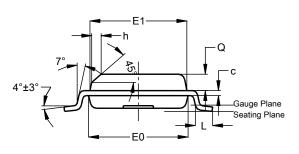
## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.







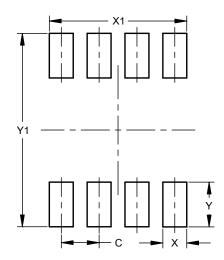


SO-8						
Dim	Min	Max	Тур			
Α	1.40	1.50	1.45			
<b>A</b> 1	0.10	0.20	0.15			
b	0.30	0.50	0.40			
С	0.15	0.25	0.20			
D	4.85	4.95	4.90			
Е	5.90	6.10	6.00			
E1	3.80	3.90	3.85			
E0	3.85	3.95	3.90			
е			1.27			
h	-		0.35			
L	0.62	0.82	0.72			
Q	0.60	0.70	0.65			
All Dimensions in mm						

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

**SO-8** 



Dimensions	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Υ	1.505
Y1	6.50



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